

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Teng-Chun TSAI</td> <td>03/15/2011</td> </tr> <tr> <td>Chun-Yuan WU</td> <td>03/15/2011</td> </tr> <tr> <td>Chin-Fu LIN</td> <td>03/15/2011</td> </tr> <tr> <td>Chih-Chien LIU</td> <td>03/15/2011</td> </tr> <tr> <td>Chin-Cheng CHIEN</td> <td>03/15/2011</td> </tr> </tbody> </table>		Name	Execution Date	Teng-Chun TSAI	03/15/2011	Chun-Yuan WU	03/15/2011	Chin-Fu LIN	03/15/2011	Chih-Chien LIU	03/15/2011	Chin-Cheng CHIEN	03/15/2011
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CORRESPONDENCE DATA													
<p>Fax Number: (703)880-7487</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 703-684-4411</p> <p>Email: faxva@WPAT.COM</p> <p>Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS</p> <p>Address Line 1: 1940 Duke St., Suite 200</p> <p>Address Line 4: Alexandria, VIRGINIA 22314</p>													
ATTORNEY DOCKET NUMBER:	66007-342												
NAME OF SUBMITTER:	Justin King												
<p>Total Attachments: 2</p> <p>source=Assignment#page 1.tif</p>													

OP \$40.00 13052338

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PATENT
REEL: 025988 FRAME: 0743

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Teng-Chun TSAI, Chun-Yuan WU,
Chin-Fu LIN, Chih-Chien LIU, Chin-Cheng CHIEN

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to

FIN FIELD-EFFECT TRANSISTOR STRUCTURE AND MANUFACTURING PROCESS THEREOF

[x] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;

[] said application having been filed in the United States Patent and Trademark Office on _____,
(Application Serial No. _____) the application serial number of said application when known;

[] said application having been filed under the Patent Cooperation Treaty on _____,
(Serial No. _____) the United States of America being designated.

AND WHEREAS United Microelectronics Corporation

who's address is NO. 3, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,
TAIWAN, R. O. C.

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

Teng-Chun TSAI
Name of sole or first inventor Signature Date
MAR 15 2011

Chun-Yuan WU
Name of second inventor, if any Signature Date
MAR 15 2011

Chin-Fu LIN
Name of third inventor, if any Signature Date
MAR 15 2011

Chih-Chien LIU
Name of fourth inventor, if any Signature Date
MAR 15 2011

Chin-Cheng CHIEN
Name of fifth inventor, if any Signature Date
MAR 15 2011